

## GaAs MMIC SP4T NON-REFLECTIVE SWITCH, DC - 18 GHz

### Typical Applications

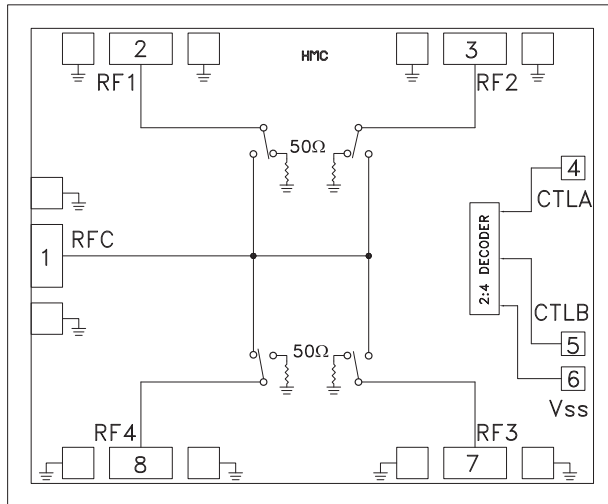
The HMC641 is ideal for:

- Telecom Infrastructure
- Microwave Radio & VSAT
- Military & Space Hybrids
- Test Instrumentation

### Features

- Broadband Performance: DC - 18 GHz
- High Isolation: 42 dB @ 12 GHz
- Low Insertion Loss: 2.1 dB @ 12 GHz
- Integrated 2:4 TTL Decoder
- Small Size: 1.92 x 1.60 x 0.10 mm

### Functional Diagram



### General Description

The HMC641 is a broadband non-reflective GaAs PHEMT SP4T switch chip. Covering DC to 18 GHz, this switch offers high isolation and low insertion loss and extends the frequency coverage of Hittite's SP4T switch product line. This switch also includes an on board binary decoder circuit which reduces the number of required logic control lines to two. The switch operates using a negative control voltage of 0/-5V, and requires a fixed Vss bias of -5V. All data is tested with the chip in a 50 Ohm test fixture connected via one 3.0 x 0.5 mil gold ribbon of minimal length on each RF port.

### Electrical Specifications, $T_A = +25^\circ \text{C}$ , With 0/-5V Control, Vss = -5V, 50 Ohm System

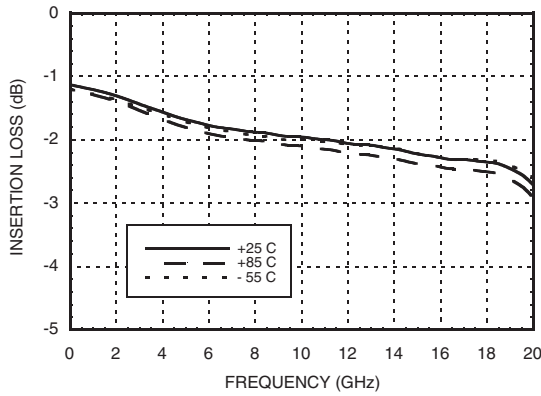
Parameter	Frequency	Min.	Typ.	Max.	Units
Insertion Loss	DC - 12 GHz		1.8	2.1	dB
	DC - 18 GHz		2.8	3.1	dB
Isolation (RFC to RF1 - RF4)	DC - 12 GHz	39	42		dB
	DC - 18 GHz	37	40		dB
Return Loss	"On State"	DC - 12 GHz	12	15	dB
		DC - 18 GHz	11	14	dB
Return Loss	"Off State"	DC - 18 GHz	12	15	dB
Input Power for 1 dB Compression	2.05 - 18 GHz	21	24		dBm
Input Third Order Intercept (Two-Tone Input Power = +14 dBm Each Tone)	0.05 - 18 GHz	37	40		dBm
Switching Characteristics	DC - 18GHz	tRISE, tFALL (10/90% RF)	14		ns
		tON, tOFF (50% CTL to 10/90% RF)	95		ns

For price, delivery, and to place orders, please contact Hittite Microwave Corporation:  
20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373

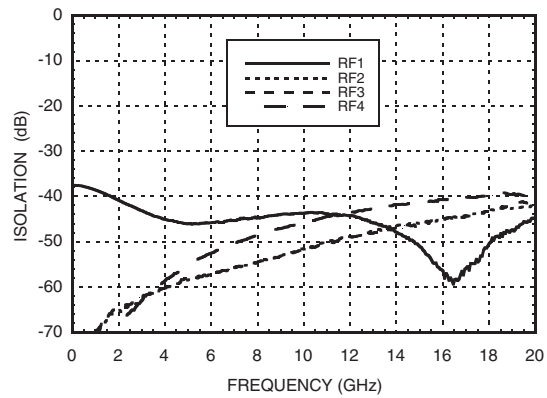
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**www.BDTIC.com/Hittite/**

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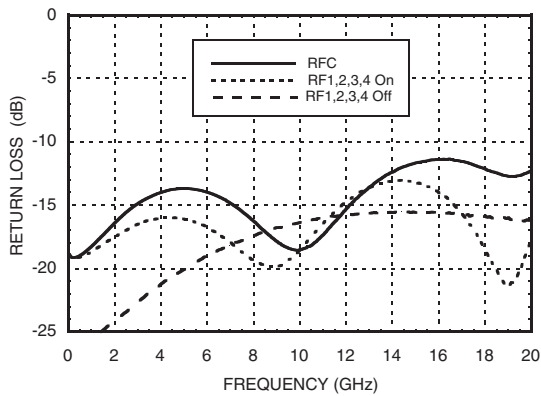
**Insertion Loss vs. Temperature**



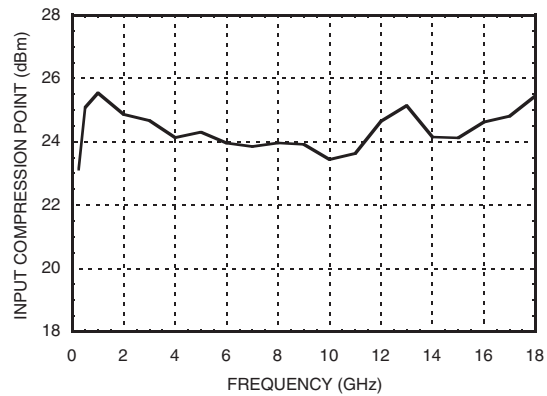
**Isolation**



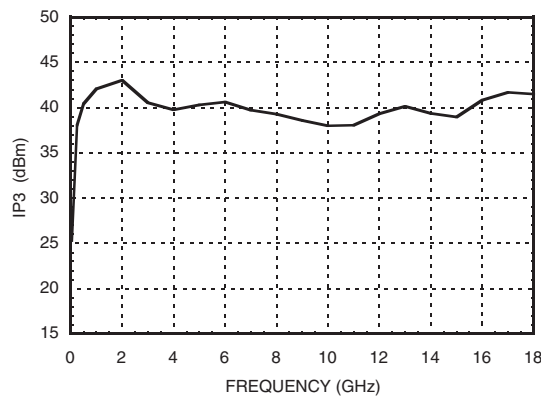
**Return Loss**



**1 dB Input Compression Point**

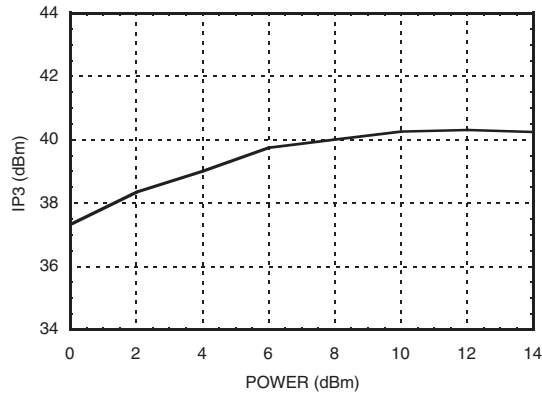


**Input Third Order Intercept Point @ +14 dBm Tone Power**

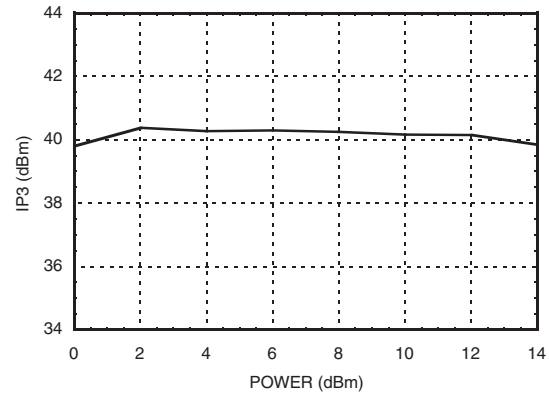


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**IP3 vs. Input Tone Power @ 500 MHz**



**IP3 vs. Input Tone Power @ 12 GHz**



**Absolute Maximum Ratings**

Bias Voltage Range (Vss)	-7 Vdc
Control Voltage Range (A & B)	Vss -0.5V to +1 Vdc
Channel Temperature	150 °C
Thermal Resistance Channel to die bottom (Insertion Loss Path)	188 °C/W
Thermal Resistance Channel to die bottom (Terminated Path)	222 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C
Maximum Input Power	+24 dBm

**Truth Table**

Control Input		Signal Path State
A	B	RFC to:
High	High	RF1
Low	High	RF2
High	Low	RF3
Low	Low	RF4

**Bias Voltage & Current**

Vss Range= -5.0 Vdc ±10%		
Vss (Vdc)	Iss (Typ) (mA)	Iss (Max) (mA)
-5	3	6



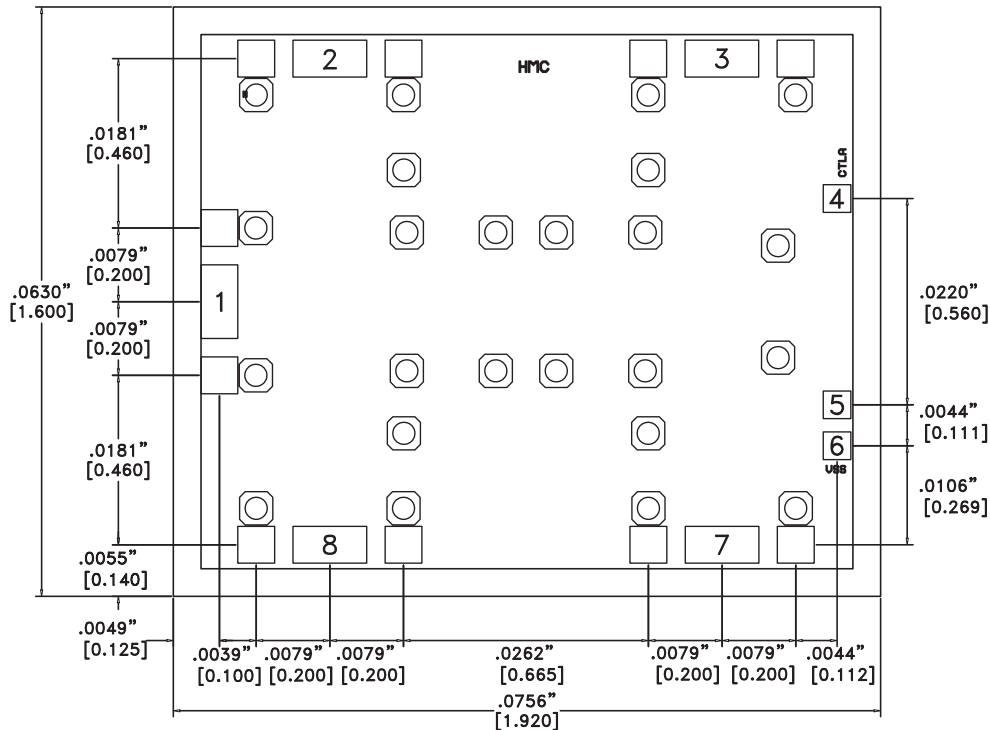
**ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS**

**TTL/CMOS Control Voltages**

State	Bias Condition
Low	-3V to 0 Vdc @ 60 uA Typ.
High	-5 to -4.2 Vdc @ 5 uA Typ.

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**Outline Drawing**



**Die Packaging Information [1]**

Standard	Alternate
WP-18 (Waffle Pack)	[2]

[1] Refer to the "Packaging Information" section for die packaging dimensions.

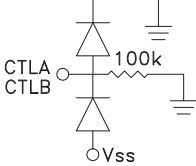

[2] For alternate packaging information contact Hittite Microwave Corporation.

**NOTES:**

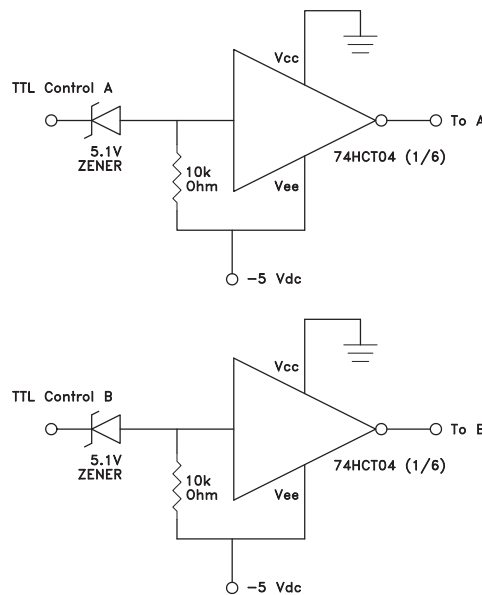
1. DIMENSIONS IN INCHES [MILLIMETERS].
2. DIE THICKNESS IS 0.004".
3. TYPICAL BOND PAD IS 0.004" SQUARE.
4. TYPICAL BOND PAD SPACING IS 0.006" CENTER TO CENTER.
5. BOND PAD METALLIZATION: GOLD.
6. BACKSIDE METALLIZATION: GOLD.
7. BACKSIDE METAL IS GROUND.
8. NO CONNECTION REQUIRED FOR UNLABELED BOND PADS.

## GaAs MMIC SP4T NON-REFLECTIVE SWITCH, DC - 18 GHz

### Pad Descriptions

Pad Number	Function	Description	Interface Schematic
1, 2, 3, 7, 8	RFC, RF1, RF2, RF3, RF4	These pads are DC coupled and matched to 50 Ohms. Blocking capacitors are required if RF line potential is not equal to 0V.	
4	CTLA	See Truth Table and Control Voltage Table.	
5	CTLB	See Truth Table and Control Voltage Table.	
6	Vss	Supply Voltage -5.0 Vdc ± 10%.	
Die Bottom	GND	Die Bottom must be connected to RF/DC ground.	

### TTL Interface Circuit



*Note:*  
Control inputs A and B can be driven directly with TTL logic with -5 Volts applied to the HCT logic gates Vee pin and to Vss Pad of the RF Switch.

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**Assembly Diagram**

